



NEWS

Buc, 13th of May 2020 – We are proud to announce that the 3D PLUS SMD assembly line has been certified on May 1st, 2020 and included in our PID 3300-0546-12 with the PCA-351A rev1.

The production and test line remains certified following the requirements of ESCC Basic specification No. 2566001 for our 3D stacking technology. ESCC N°2566001 standard is the reference for the definition and evolution of the Process Capability Approval (PCA) that includes 3D PLUS' manufacturing, assembly and test operations which have been approved for the supply of non-hermetic modules for use in ESA space systems.

The associated Process Identification Document (PID), Ref. 330-0546-12 Amdt 1 (PID Rev. 12 Amendment 1), covers the 3D PLUS' activities on manufacturing, tuning, testing, inspection and Quality Assurance of 3D PLUS' catalogue and custom products.

With this PID renewal which includes the SMD assembly line, 3D PLUS keeps improving its capability domain, to reinforce our products' reliability, reduce manufacturing lead-time and give access to new products for space to our customers.

For more than 20 years, 3D PLUS has the only production line of electronic modules fully space qualified in accordance with ESA certification.

About 3D PLUS:

3D PLUS is a French SME, world leader in the design and manufacturing of high-performance and high reliability components miniaturized with its unique 3D vertical interconnect technology.

With more than 160,000 modules into space early 2020 and a production of more than 30,000 space qualified modules per year in its facility nearby Paris, 3D PLUS provides all stakeholders of the global space industry for over 20 years for telecommunications applications, Earth observation, navigation, launchers and human spaceflight, science missions, small satellites and constellations.